PRELIMINARY

8042/8742
UNIVERSAL PERIPHERAL INTERFACE 8-BIT MICROCOMPUTER

- **8042/8742: 12 MHz**
- **Pin, Software and Architecturally Compatible with 8041A/8741A/8041AH**
- **8-Bit CPU plus ROM, RAM, I/O, Timer and Clock in a Single Package**
- **2048 x 8 ROM/EPROM, 128 x 8 RAM, 8-Bit Timer/Counter, 18 Programmable I/O Pins**
- **One 8-Bit Status and Two Data Registers for Asynchronous Slave-to-Master Interface**
- **DMA, Interrupt, or Polled Operation Supported**
- **Fully Compatible with MCS-48™, MCS-51™, MCS-80™, MCS-85™, and iAPX-86, 88 Microprocessor Families**
- **Interchangeable ROM and EPROM Versions**
- **Expandable I/O**
- **RAM Power-Down Capability**
- **Over 90 Instructions: 70% Single Byte**
- **Single 5V Supply**

The Intel 8042/8742 is a general-purpose Universal Peripheral Interface that allows the designer to grow his own customized solution for peripheral device control. It contains a low-cost microcomputer with 2K of program memory, 128 bytes of data memory, 8-bit CPU, I/O ports, 8-bit timer/counter, and clock generator in a single 40-pin package. Interface registers are included to enable the UPI device to function as a peripheral controller in the MCS-48™, MCS-51™, MCS-80™, MCS-85™, iAPX-88, iAPX-86 and other 8-, 16-bit systems.

The 8042/8742 is software, pin, and architecturally compatible with the 8041AH, 8741A. The 8042/8742 doubles the on-chip memory space to allow for additional features and performance to be incorporated in upgraded 8041AH/8741A designs. For new designs, the additional memory and performance of the 8042/8742 extends the UPI concept to more complex motor control tasks, 80-column printers and process control applications as examples.

To allow full user flexibility, the program memory is available as ROM in the 8042 version or as UV-erasable EPROM in the 8742 version. The 8742 and the 8042 are fully pin compatible for easy transition from prototype to production level designs. The 8642 is a one-time programmable (at the factory) 8742 which can be ordered as the first 25 pieces of a new 8042 order. The substitution of 8642's for 8042's allows for very fast turnaround for initial code verification and evaluation results.

The device has two 8-bit, TTL compatible I/O ports and two test inputs. Individual port lines can function as either inputs or outputs under software control. I/O can be expanded with the 8243 device which is directly compatible and has 16 I/O lines. An 8-bit programmable timer/counter is included in the UPI device for generating timing sequences or counting external inputs. Additional UPI features include: single 5V supply, low power standby mode (in the 8042), single-step mode for debug, and dual working register banks.

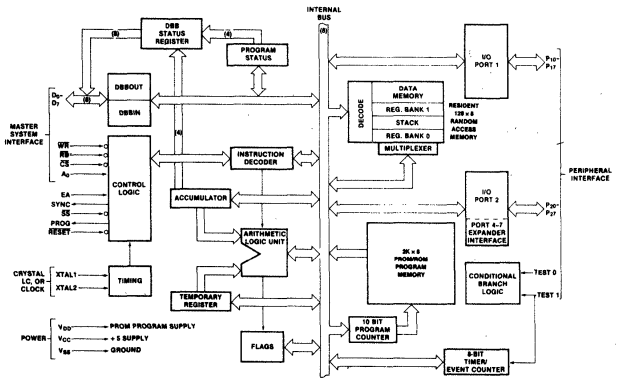


Figure 1. Block Diagram

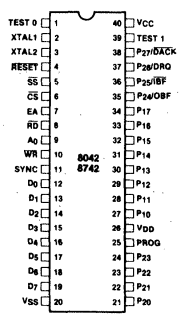


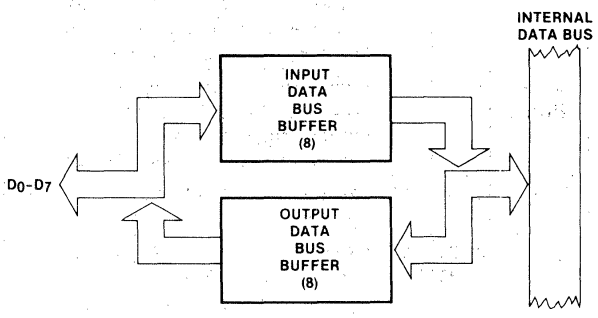
Figure 2. Pin Configuration

Table 1. Pin Description

Symbol	Pin No.	Type	Name and Function
TEST 0, TEST 1	1 39	I	**Test Inputs:** Input pins which can be directly tested using conditional branch instructions. **Frequency Reference:** TEST 1 (T_1) also functions as the event timer input (under software control). TEST 0 (T_0) is used during PROM programming and verification in the 8742.
XTAL 1, XTAL 2	2 3	I	**Inputs:** Inputs for a crystal, LC or an external timing signal to determine the internal oscillator frequency.
$\overline{\text{RESET}}$	4	I	**Reset:** Input used to reset status flip-flops and to set the program counter to zero. $\overline{\text{RESET}}$ is also used during PROM programming and verification.
$\overline{\text{SS}}$	5	I	**Single Step:** Single step input used in conjunction with the SYNC output to step the program through each instruction.
$\overline{\text{CS}}$	6	I	**Chip Select:** Chip select input used to select one UPI microcomputer out of several connected to a common data bus.
EA	7	I	**External Access:** External access input which allows emulation, testing and PROM/ROM verification. This pin should be tied low if unused.
$\overline{\text{RD}}$	8	I	**Read:** I/O read input which enables the master CPU to read data and status words from the OUTPUT DATA BUS BUFFER or status register.
A_0	9	I	**Command/Data Select:** Address input used by the master processor to indicate whether byte transfer is data ($A_0 = 0$, F1 is reset) or command ($A_0 = 1$, F1 is set).
$\overline{\text{WR}}$	10	I	**Write:** I/O write input which enables the master CPU to write data and command words to the UPI INPUT DATA BUS BUFFER.
SYNC	11	O	**Output Clock:** Output signal which occurs once per UPI-42 instruction cycle. SYNC can be used as a strobe for external circuitry; it is also used to synchronize single step operation.
D_0-D_7 (BUS)	12-19	I/O	**Data Bus:** Three-state, bidirectional DATA BUS BUFFER lines used to interface the UPI-42 microcomputer to an 8-bit master system data bus.
P_{10}-P_{17}	27-34	I/O	**Port 1:** 8-bit, PORT 1 quasi-bidirectional I/O lines.
P_{20}-P_{27}	21-24 35-38	I/O	**Port 2:** 8-bit, PORT 2 quasi-bidirectional I/O lines. The lower 4 bits (P_{20}-P_{23}) interface directly to the 8243 I/O expander device and contain address and data information during PORT 4-7 access. The upper 4 bits (P_{24}-P_{27}) can be programmed to provide interrupt Request and DMA Handshake capability. Software control can configure P_{24} as Output Buffer Full (OBF) interrupt, P_{25} as Input Buffer Full ($\overline{\text{IBF}}$) interrupt, P_{26} as DMA Request (DRQ), and P_{27} as DMA ACKnowledge ($\overline{\text{DACK}}$).
PROG	25	I/O	**Program:** Multifunction pin used as the program pulse input during PROM programming. During I/O expander access the PROG pin acts as an address/data strobe to the 8243. This pin should be tied high if unused.
V_{CC}	40		**Power:** +5V main power supply pin.
V_{DD}	26		**Power:** +5V during normal operation. +21V during programming operation. Low power standby pin in ROM version.
V_{SS}	20		**Ground:** Circuit ground potential.

UPI-42 FEATURES

1. Two Data Bus Buffers, one for input and one for output. This allows a much cleaner Master/Slave protocol.



2. 8 Bits of Status

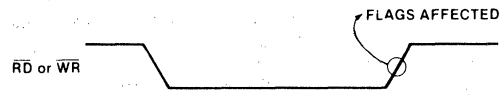
ST_7	ST_6	ST_5	ST_4	F_1	F_0	IBF	OBF
D_7	D_6	D_5	D_4	D_3	D_2	D_1	D_0

ST_4-ST_7 are user definable status bits. These bits are defined by the "MOV STS, A" single byte, single cycle instruction. Bits 4-7 of the accumulator are moved to bits 4-7 of the status register. Bits 0-3 of the status register are not affected.

MOV STS, A Op Code: 90H

1	0	0	1	0	0	0	0
D_7							D_0

3. $\overline{RD}$ and $\overline{WR}$ are edge triggered. IBF, OBF, F_1 and INT change internally after the trailing edge of $\overline{RD}$ or $\overline{WR}$.

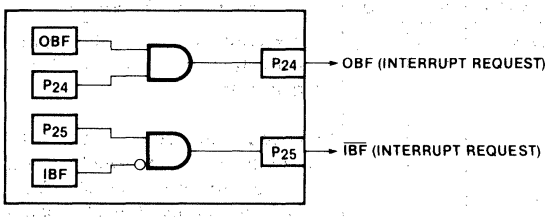


During the time that the host CPU is reading the status register, the 8042/8742 is prevented from updating this register or is 'locked out.'

4. P_{24} and P_{25} are port pins or Buffer Flag pins which can be used to interrupt a master processor. These pins default to port pins on Reset.

   If the "EN FLAGS" instruction has been executed, P_{24} becomes the OBF (Output Buffer Full) pin. A "1" written to P_{24} enables the OBF pin (the pin outputs the OBF Status Bit). A "0" written to P_{24} disables the OBF pin (the pin remains low). This pin can be used to indicate that valid data is available from the UPI-41A (in Output Data Bus Buffer).

   If "EN FLAGS" has been executed, P_{25} becomes the $\overline{IBF}$ (Input Buffer Full) pin. A "1" written to P_{25} enables the $\overline{IBF}$ pin (the pin outputs the inverse of the IBF Status Bit). A "0" written to P_{25} disables the $\overline{IBF}$ pin (the pin remains low). This pin can be used to indicate that the UPI-42 is ready for data.



DATA BUS BUFFER INTERRUPT CAPABILITY

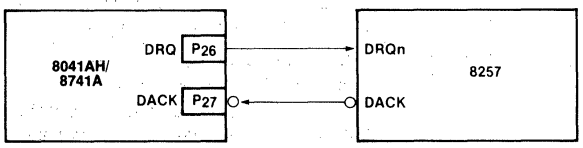
EN FLAGS Op Code: 0F5H

1	1	1	1	0	1	0	1
D_7							D_0

5. P_{26} and P_{27} are port pins or DMA handshake pins for use with a DMA controller. These pins default to port pins on Reset.

   If the "EN DMA" instruction has been executed, P_{26} becomes the DRQ (DMA ReQuest) pin. A "1" written to P_{26} causes a DMA request (DRQ is activated). DRQ is deactivated by DACK·RD, DACK·WR, or execution of the "EN DMA" instruction.

   If "EN DMA" has been executed, P_{27} becomes the $\overline{DACK}$ (DMA ACKnowledge) pin. This pin acts as a chip select input for the Data Bus Buffer registers during DMA transfers.



DMA HANDSHAKE CAPABILITY

EN DMA Op Code: 0E5H

1	1	1	0	0	1	0	1
D_1							D_0

6. The RESET input on the 8042/8742 includes a 2-stage synchronizer to support reliable reset operation for 12 MHz operation.

7. When EA is enabled on the 8042/8742, the program counter is placed on Port 1 and the lower three bits of Port 2 (MSB = P_{22}, LSB = P_{10}). On the 8042/8742 this information is multiplexed with PORT DATA (see port timing diagrams at end of this data sheet).

8. The 8042/8742 supports single step mode as described in the pin description section.

APPLICATIONS

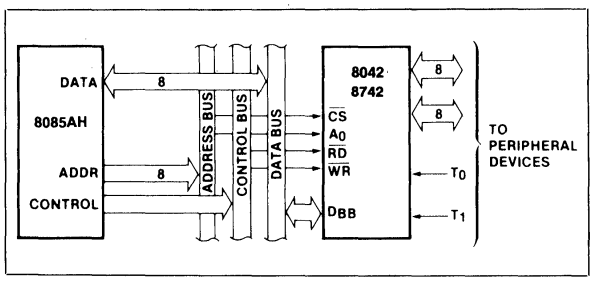


Figure 3. 8085AH-8042/8742 Interface

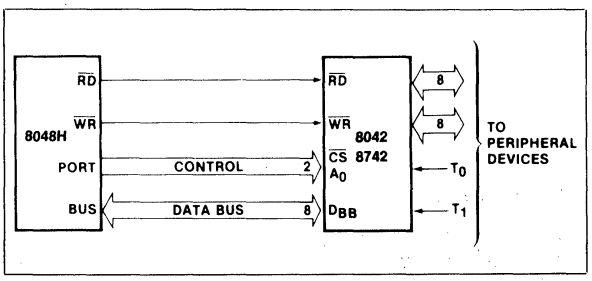


Figure 4. 8048H-8042/8742 Interface

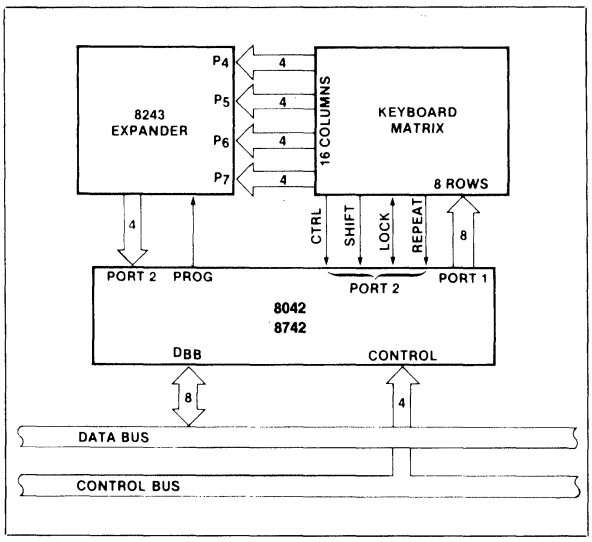


Figure 5. 8042/8742-8243 Keyboard Scanner

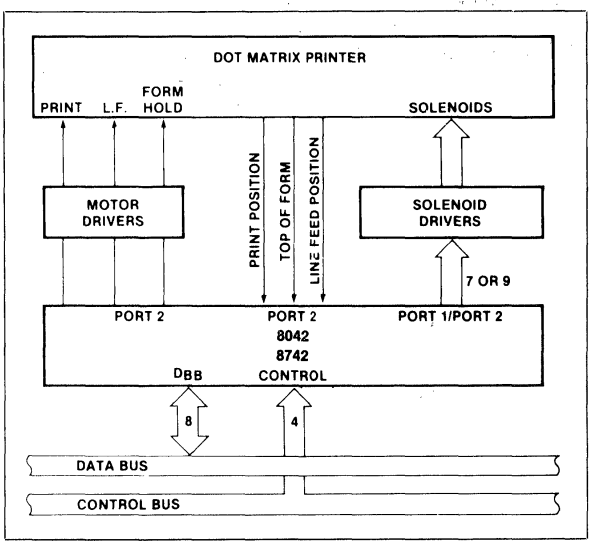


Figure 6. 8042/8742 80-Column Matrix Printer Interface

PROGRAMMING, VERIFYING, AND ERASING THE 8742 EPROM

Programming Verification

In brief, the programming process consists of: activating the program mode, applying an address, latching the address, applying data, and applying a programming pulse. Each word is programmed completely before moving on to the next and is followed by a verification step. The following is a list of the pins used for programming and a description of their functions:

Pin	Function
XTAL 1	Clock Input (1 to 12MHz)
$\overline{\text{Reset}}$	Initialization and Address Latching
Test 0	Selection of Program or Verify Mode
EA	Activation of Program/Verify Modes
BUS	Address and Data Input Data Output During Verify
P20-1	Address Input
V_{DD}	Programming Power Supply
PROG	Program Pulse Input

WARNING

An attempt to program a missocketed 8742 will result in severe damage to the part. An indication of a properly socketed part is the appearance of the SYNC clock output. The lack of this clock may be used to disable the programmer.

The Program/Verify sequence is:

1. A_0 = 0V, $\overline{CS}$ = 5V, EA = 5V, $\overline{RESET}$ = 0V, TEST0 = 5V, V_{DD} = 5V, clock applied or internal oscillator operating, BUS and PROG floating.
2. Insert 8742 in programming socket
3. TEST 0 = 0v (select program mode)
4. EA = 21V (active program mode)*
5. Address applied to BUS and P_{20-22}
6. $\overline{RESET}$ = 5v (latch address)
7. Data applied to BUS**
8. V_{DD} = 21V (programming power)**
9. PROG = 0v followed by one 50 ms pulse to 21V**
10. V_{DD} = 5v
11. TEST 0 = 5v (verify mode)

12. Read and verify data on BUS
13. TEST 0 = 0v
14. $\overline{RESET}$ = 0v and repeat from step 5
15. Programmer should be at conditions of step 1 when 8742 is removed from socket

*When verifying ROM, EA = 12V.
**Not used in verifying ROM procedure.

8742 Erasure Characteristics

The erasure characteristics of the 8742 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000-4000Å range. Data show that constant exposure to room level fluorescent lighting could erase the typical 8742 in approximately 3 years while it would take approximately one week to cause erasure when exposed to direct sunlight. If the 8742 is to be exposed to these types of lighting conditions for extended periods of time, opaque labels are available from Intel which should be placed over the 8742 window to prevent unintentional erasure.

The recommended erasure procedure for the 8742 is exposure to shortwave ultraviolet light which has a wavelength of 2537Å. The integrated dose (i.e., UV intensity × exposure time) for erasure should be a minimum of 15 w-sec/cm^2. The erasure time with this dosage is approximately 15 to 20 minutes using an ultraviolet lamp with a 12,000 μW/cm^2 power rating. The 8742 should be placed within one inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure.

ABSOLUTE MAXIMUM RATINGS*

Ambient Temperature Under Bias . . . . . 0°C to 70°C
Storage Temperature . . . . . −65°C to +150°C
Voltage on Any Pin With Respect to Ground . . . . . −0.5V to +7V
Power Dissipation . . . . . 1.5 Watt

**NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.*

D.C. CHARACTERISTICS ($T_A = 0°$ to $+70°C$, $V_{CC} = V_{DD} = +5V \pm 10\%$)

Symbol	Parameter	8042		8742/8642		Units	Notes
		Min.	Max.	Min.	Max.		
V_{IL}	Input Low Voltage (Except XTAL1, XTAL2, RESET)	−0.5	0.8	−0.5	0.8	V	
V_{IL1}	Input Low Voltage (XTAL1, XTAL2, RESET)	−0.5	0.6	−0.5	0.6	V	
V_{IH}	Input High Voltage (Except XTAL1, XTAL2, RESET)	2.2	V_{CC}	2.2	V_{CC}	V	
V_{IH1}	Input High Voltage (XTAL1, XTAL2, RESET)	3.8	V_{CC}	3.8	V_{CC}	V	
V_{OL}	Output Low Voltage (D_0-D_7)		0.45		0.45	V	$I_{OL} = 2.0$ mA
V_{OL1}	Output Low Voltage ($P_{10}P_{17}$, $P_{20}P_{27}$, Sync)		0.45		0.45	V	$I_{OL} = 1.6$ mA
V_{OL2}	Output Low Voltage (PROG)		0.45		0.45	V	$I_{OL} = 1.0$ mA
V_{OH}	Output High Voltage (D_0-D_7)	2.4		2.4		V	$I_{OH} = -400\ \mu A$
V_{OH1}	Output High Voltage (All Other Outputs)	2.4		2.4		V	$I_{OH} = -50\ \mu A$
I_{IL}	Input Leakage Current (T_0, T_1, RD, WR, CS, A_0, EA)		±10		±10	μA	$V_{SS} \le V_{IN} \ge V_{CC}$
I_{OZ}	Output Leakage Current (D_0-D_7, High Z State)		±10		±10	μA	$V_{SS} + 0.45 \le V_{OUT} \le V_{CC}$
I_{LI}	Low Input Load Current ($P_{10}P_{17}$, $P_{20}P_{27}$)		0.3		0.3	mA	$V_{IL} = 0.8V$
I_{LI1}	Low Input Load Current (RESET, SS)		0.2		0.2	mA	$V_{IL} = 0.8V$
I_{DD}	V_{DD} Supply Current		15		15	mA	Typical = 5 mA
$I_{CC} + I_{DD}$	Total Supply Current		125		125	mA	Typical=60 mA
I_{IH}	Input Leakage Current		100		100	μA	$V_{IN} = V_{CC}$
C_{IN}	Input Capacitance		10		10	pF	
$C_{I/O}$	I/O Capacitance		20		20	pF	

D.C. CHARACTERISTICS—PROGRAMMING ($T_A = 25°C \pm 5°C$, $V_{CC} = 5V \pm 5\%$, $V_{DD} = 21V \pm 1V$)

Symbol	Parameter	Min.	Max.	Unit	Test Conditions
V_{DOH}	V_{DD} Program Voltage High Level	20.0	22.0	V	
V_{DDL}	V_{DD} Voltage Low Level	4.75	5.25	V	
V_{PH}	PROG Program Voltage High Level	21.5	24.5	V	
V_{PL}	PROG Voltage Low Level		0.2	V	
V_{EAH}	EA Program or Verify Voltage High Level	21.5	24.5	V	
V_{EAL}	EA Voltage Low Level		5.25	V	
I_{DD}	V_{DD} High Voltage Supply Current		30.0	mA	
I_{PROG}	PROG High Voltage Supply Current		16.0	mA	
I_{EA}	EA High Voltage Supply Current		1.0	mA	

A.C. CHARACTERISTICS ($T_A = 0°C$ to $+70°C$, $V_{SS} = 0V$, $V_{CC} = V_{DD} = +5V \pm 10\%$)

DBB READ

Symbol	Parameter	8042		8642/8742		Units
		Min.	Max.	Min.	Max.	
t_{AR}	CS, A_0 Setup to RD↓	0		0		ns
t_{RA}	CS, A_0 Hold After RD↑	0		0		ns
t_{RR}	RD Pulse Width	160		160		ns
t_{AD}	CS, A_0 to Data Out Delay		130		130	ns[1]
t_{RD}	RD↓ to Data Out Delay		130		130	ns[1]
t_{DF}	RD↑ to Data Float Delay		85		85	ns
t_{CY}	Cycle Time	1.25	15	1.25	15	μs[2]

DBB WRITE

Symbol	Parameter	Min.	Max.	Min.	Max.	Units
t_{AW}	CS, A_0 Setup to WR↓	0		0		ns
t_{WA}	CS, A_0 Hold After WR↑	0		0		ns
t_{WW}	WR Pulse Width	160		260		ns
t_{DW}	Data Setup to WR↑	130		150		ns
t_{WD}	Data Hold After WR↑	0		0		ns

NOTES:
1. $C_L = 100$ pF.
2. 12 MHz XTAL.

A.C. CHARACTERISTICS—PROGRAMMING ($T_A = 25°C \pm 5°C$, $V_{CC} = 5V \pm 5\%$, $V_{DD} = 21V \pm 1V$)

Symbol	Parameter	Min.	Max.	Unit	Test Conditions
t_{AW}	Address Setup Time to $\overline{RESET}$ ↑	4tCY			
t_{WA}	Address Hold Time After $\overline{RESET}$ ↑	4tCY			
t_{DW}	Data in Setup Time to PROG ↑	4tCY			
t_{WD}	Data in Hold Time After PROG ↓	4tCY			
t_{PH}	$\overline{RESET}$ Hold Time to Verify	4tCY			
t_{VDDW}	V_{DD} Setup Time to PROG ↑	4tCY			
t_{VDDH}	V_{DD} Hold Time After PROG ↓	0			
t_{PW}	Program Pulse Width	50	60	mS	
t_{TW}	Test 0 Setup Time for Program Mode	4tCY			
t_{WT}	Test 0 Hold Time After Program Mode	4tCY			
t_{DO}	Test 0 to Data Out Delay		4tCY		
t_{WW}	$\overline{RESET}$ Pulse Width to Latch Address	4tCY			
t_r, t_f	V_{DD} and PROG Rise and Fall Times	0.5	2.0	μs	
t_{CY}	CPU Operation Cycle Time	5.0		μs	
t_{RE}	$\overline{RESET}$ Setup Time Before EA ↑.	4tCY			

Note: If TEST 0 is high, t_{DO} can be triggered by $\overline{RESET}$ ↑.

A.C. CHARACTERISTICS DMA

Symbol	Parameter	8042		8642/8742		Units
		Min.	Max.	Min.	Max.	
t_{ACC}	DACK to WR or RD	0		0		ns
t_{CAC}	RD or WR to DACK	0		0		ns
t_{ACD}	DACK to Data Valid		130		130	ns[1]
t_{CRQ}	RD or WR to DRQ Cleared		90		90	ns

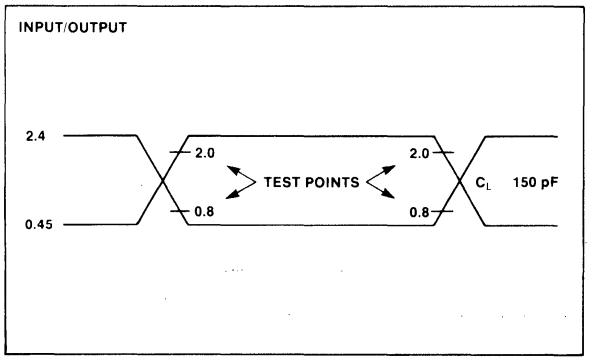
NOTE:
1. $C_L = 150$ pF.

A.C. CHARACTERISTICS PORT 2 ($T_A = 0°C$ to $+70°C$, $V_{CC} = +5V \pm 10\%$)

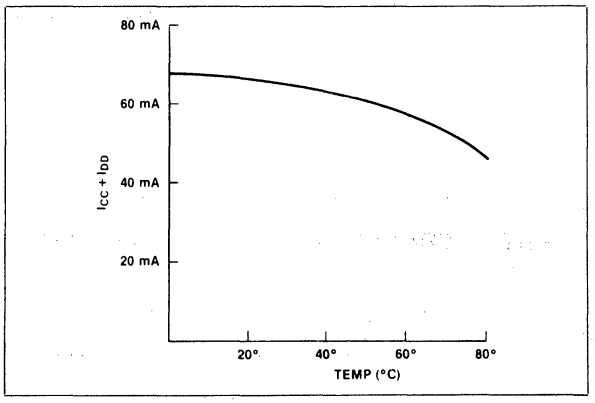
Symbol	Parameter	8042		8642/8742		Units
		Min.	Max.	Min.	Max.	
t_{CP}	Port Control Setup Before Falling Edge of PROG	100		100		ns[1]
t_{PC}	Port Control Hold After Falling Edge of PROG	60		60		ns[2]
t_{PR}	PROG to Time P2 Input Must Be Valid		650		650	ns[1]
t_{PF}	Input Data Hold Time	0	150	0	150	ns[2]
t_{DP}	Output Data Setup Time	200		200		ns[1]
t_{PD}	Output Data Hold Time	60		60		ns[2]
t_{PP}	PROG Pulse Width	700		700		ns

NOTES:
1. $C_L = 80$ pF.
2. $C_L = 20$ pF.

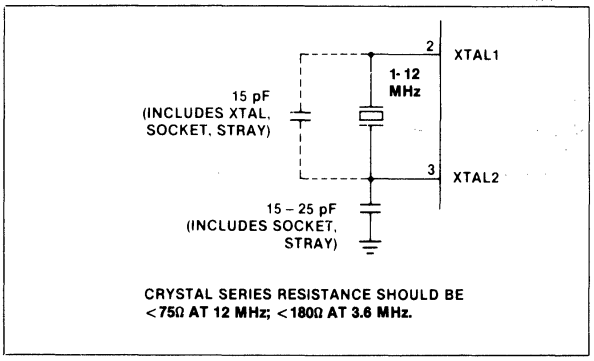
A.C. TESTING INPUT, OUTPUT WAVEFORM



TYPICAL 8042/8742 CURRENT

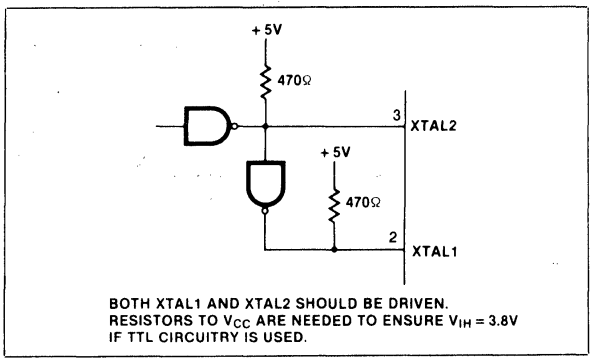


CRYSTAL OSCILLATOR MODE



CRYSTAL SERIES RESISTANCE SHOULD BE <75Ω AT 12 MHz; <180Ω AT 3.6 MHz.

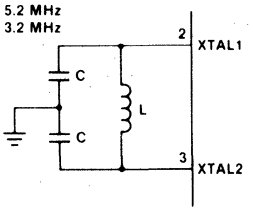
DRIVING FROM EXTERNAL SOURCE



BOTH XTAL1 AND XTAL2 SHOULD BE DRIVEN. RESISTORS TO V_{CC} ARE NEEDED TO ENSURE $V_{IH} = 3.8V$ IF TTL CIRCUITRY IS USED.

LC OSCILLATOR MODE

L	C	NOMINAL f
45 μH	20 pF	5.2 MHz
120 μH	20 pF	3.2 MHz



$$f \approx \frac{1}{2\pi\sqrt{LC'}}$$

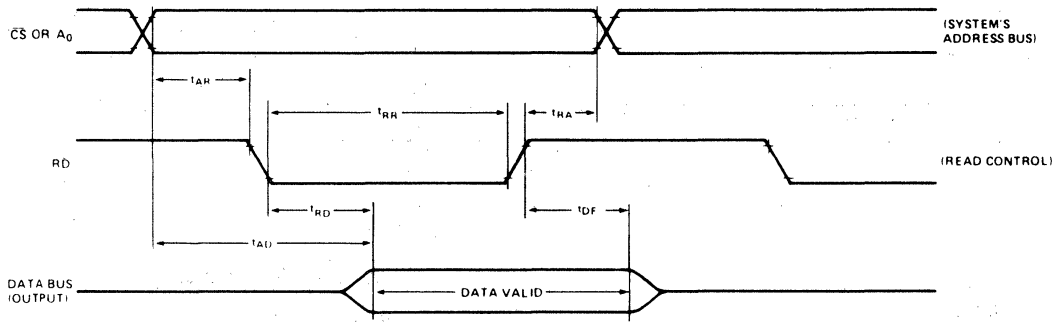
$$C' = \frac{C + 3C_{PP}}{2}$$

$C_{PP} \approx 5 - 10$ pF PIN-TO-PIN CAPACITANCE

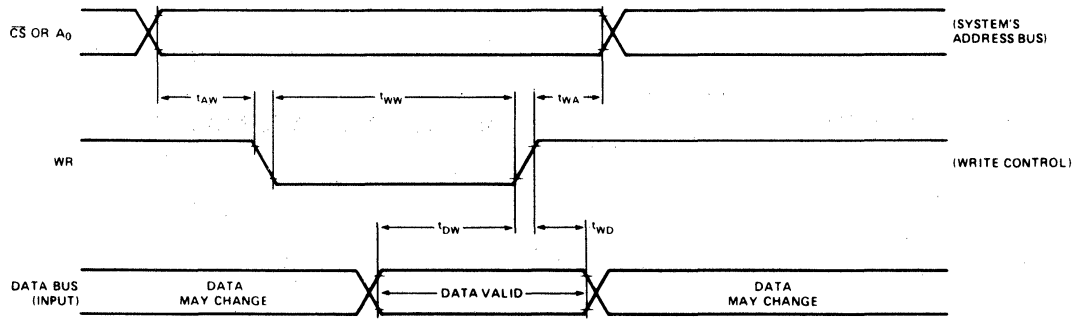
EACH C SHOULD BE APPROXIMATELY 20 pF, INCLUDING STRAY CAPACITANCE.

WAVEFORMS

READ OPERATION—DATA BUS BUFFER REGISTER

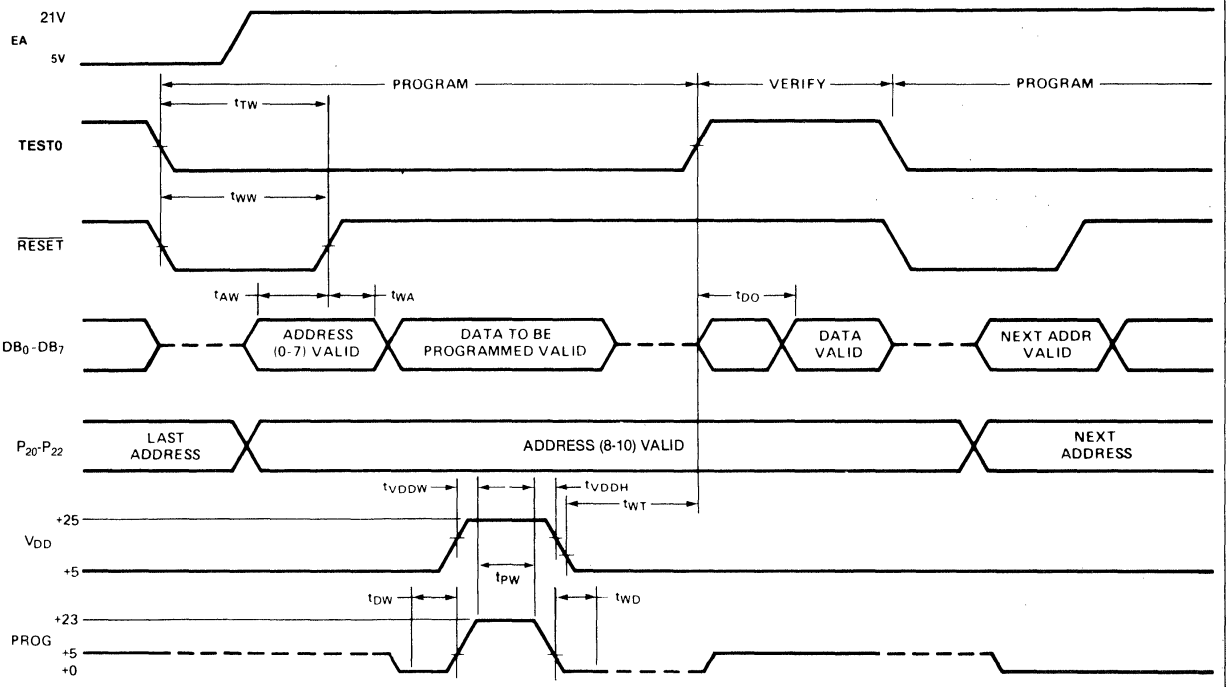


WRITE OPERATION—DATA BUS BUFFER REGISTER

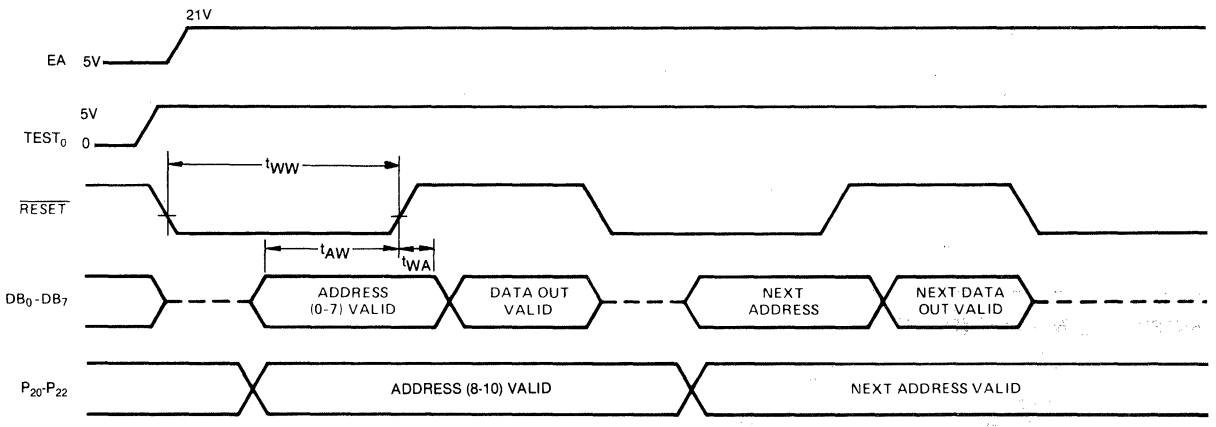


WAVEFORMS (Continued)

COMBINATION PROGRAM/VERIFY MODE (EPROM'S ONLY)



VERIFY MODE (ROM/EPROM)



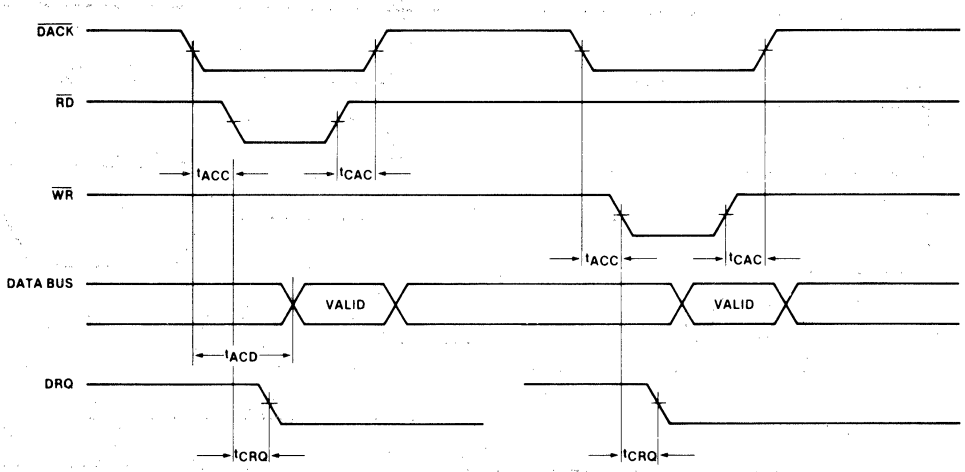
NOTES:
1. PROG MUST FLOAT IF EA IS LOW (i.e., = 21V) OR IF $TEST_0$ = 5V FOR THE 8742. FOR THE 8042 PROG MUST ALWAYS FLOAT.
2. A_0 MUST BE HELD LOW (i.e., = 0V) DURING PROGRAM/VERIFY MODES.
3. TEST 0 MUST BE HELD HIGH.

The 8742 EPROM can be programmed by the following Intel product:

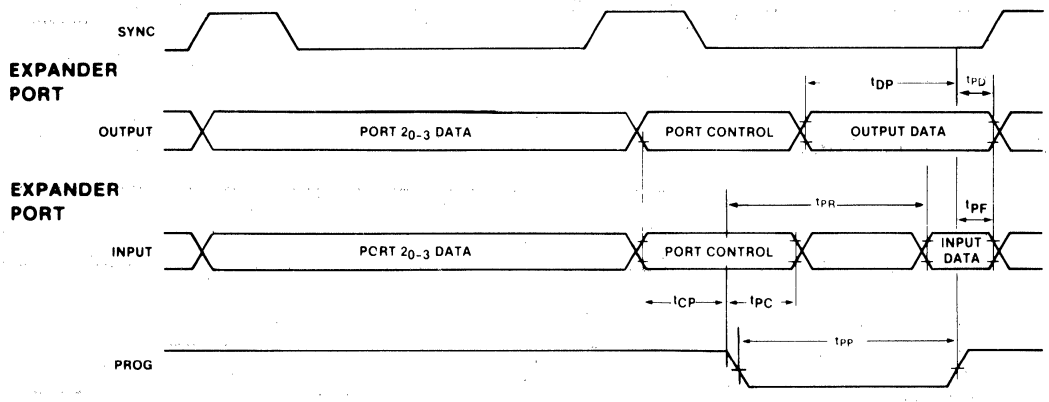
1. Universal PROM Programmer (UPP series) peripheral of the Intellec® Development System with a UPP-549 Personality Card.

WAVEFORMS (Continued)

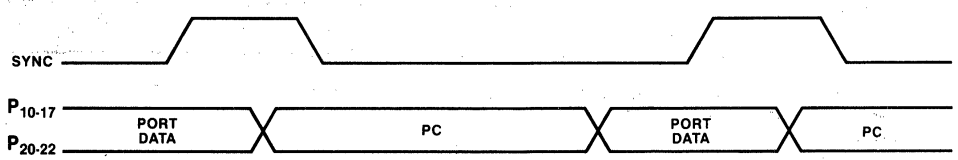
DMA



PORT 2



PORT TIMING DURING EA



ON THE RISING EDGE OF SYNC AND EA IS ENABLED, PORT DATA IS VALID AND CAN BE STROBED. ON THE TRAILING EDGE OF SYNC THE PROGRAM COUNTER CONTENTS ARE AVAILABLE.

Table 2. UPI™ Instruction Set

Mnemonic	Description	Bytes	Cycles
ACCUMULATOR			
ADD A, Rr	Add register to A	1	1
ADD A, @Rr	Add data memory to A	1	1
ADD A, #data	Add immediate to A	2	2
ADDC A, Rr	Add register to A with carry	1	1
ADDC A, @Rr	Add data memory to A with carry	1	1
ADDC A, #data	Add immediate to A with carry	2	2
ANL A, Rr	AND register to A	1	1
ANL A, @Rr	AND data memory to A	1	1
ANL A, #data	AND immediate to A	2	2
ORL A, Rr	OR register to A	1	1
ORL A, @Rr	OR data memory to A	1	1
ORL A, #data	OR immediate to A	2	2
XRL A, Rr	Exclusive OR register to A	1	1
XRL A, @Rr	Exclusive OR data memory to A	1	1
XRL A, #data	Exclusive OR immediate to A	2	2
INC A	Increment A	1	1
DEC A	Decrement A	1	1
CLR A	Clear A	1	1
CPL A	Complement A	1	1
DA A	Decimal Adjust A	1	1
SWAP A	Swap nibbles of A	1	1
RL A	Rotate A left	1	1
RLC A	Rotate A left through carry	1	1
RR A	Rotate A right	1	1
RRC A	Rotate A right through carry	1	1
INPUT/OUTPUT			
IN A, Pp	Input port toA	1	2
OUTL Pp, A	Output A to port	1	2
ANL Pp, #data	AND immediate to port	2	2
ORL Pp, #data	OR immediate to port	2	2
IN A, DBB	Input DBB to A, clear IBF	1	1
OUT DBB, A	Output A to DBB, set OBF	1	1
MOV STS, A	A_4–A_7 to Bits 4–7 of Status	1	1
MOVD A, Pp	Input Expander port to A	1	2
MOVD Pp, A	Output A to Expander port	1	2
ANLD Pp, A	AND A to Expander port	1	2
ORLD Pp, A	OR A to Expander port	1	2

Mnemonic	Description	Bytes	Cycles
DATA MOVES			
MOV A, Rr	Move register to A	1	1
MOV A, @Rr	Move data memory to A	1	1
MOV A, #data	Move immediate TO A	2	2
MOV Rr, A	Move A to register	1	1
MOV @Rr, A	Move A to data memory	1	1
MOV Rr, #data	Move immediate to register	2	2
MOV @Rr, #data	Move immediate to data memory	2	2
MOV A, PSW	Move PSW to A	1	1
MOV PSW, A	Move A to PSW	1	1
XCH A, Rr	Exchange A and register	1	1
XCH A, @Rr	Exchange A and data memory	1	1
XCHD A, @Rr	Exchange digit of A and register	1	1
MOVP A, @A	Move to A from current page	1	2
MOVP3, A, @A	Move to A from page 3	1	2
TIMER/COUNTER			
MOV A, T	Read Timer/Counter	1	1
MOV T, A	Load Timer/Counter	1	1
STRT T	Start Timer	1	1
STRT CNT	start Counter	1	1
STOP TCNT	Stop Timer/Counter	1	1
EN TCNTI	Enable Timer/ Counter Interrupt	1	1
DIS TCNTI	Disable Timer/ Counter Interrupt	1	1
CONTROL			
EN DMA	Enable DMA Handshake Lines	1	1
EN I	Enable IBF Interrupt	1	1
DIS I	Disable IBF Interrupt	1	1
EN FLAGS	Enable Master Interrupts	1	1
SEL RB0	Select register bank 0	1	1
SEL RB1	Select register bank 1	1	1
NOP	No Operation	1	1
REGISTERS			
INC Rr	Increment register	1	1
INC @Rr	Increment data memory	1	1
DEC Rr	Decrement register	1	1
SUBROUTINE			
CALL addr	Jump to subroutine	2	2
RET	Return	1	2
RETR	Return and restore status	1	2

Table 2. UPI™ Instruction Set (Continued)

Mnemonic	Description	Bytes	Cycles
FLAGS			
CLR C	Clear Carry	1	1
CPL C	Complement Carry	1	1
CLR F0	Clear Flag 0	1	1
CPL F0	Complement Flag 0	1	1
CLR F1	Clear F1 Flag	1	1
CPL F1	Complement F1 Flag	1	1
BRANCH			
JMP addr	Jump unconditional	2	2
JMPP @A	Jump indirect	1	2
DJNZ Rr, addr	Decrement register and jump	2	2
JC addr	Jump on Carry=1	2	2
JNC addr	Jump on Carry=0	2	2
JZ addr	Jump on A Zero	2	2
JNZ addr	Jump on A not Zero	2	2
JT0 addr	Jump on T0=1	2	2
JNT0 addr	Jump on T0=0	2	2
JT1 addr	Jump on T1=1	2	2
JNT1 addr	Jump on T1=0	2	2
JF0 addr	Jump on F0 Flag=1	2	2
JF1 addr	Jump on F1 Flag=1	2	2
JTF addr	Jump on Timer Flag =1, Clear Flag	2	2
JNIBF addr	Jump on IBF Flag =0	2	2
JOBF addr	Jump on OBF Flag =1	2	2
JBb addr	Jump on Accumulator Bit	2	2